DECLARATION FOR PATENT APPLICATION

As a below named inventor(s), I (we) hereby declare that:							
My (our) residence(s), post office address(es) and citizenship(s) is (are) the same as stated below next to my (our) name(s).							
	e listed below) of the subject ma	if only one name is listed below) atter which is claimed and for wh UBLE STRANDED DNA					
PCT International Appli		s Application Number		or			
I (we) hereby state that I (we) have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.							
I (we) acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.							
for patent or inventor's certificat	te listed below and have also ide	ed States Code, §119(a)-(d) of a entified below any foreign application on which priority is claime	ation for paten				
:	1	Priority Claimed:					
(Number)	(Country)	(Day/Month/Year)		YES NO			
325136/2000	JAPAN	25 OCTOBER 2000	X				
332249/2000	JAPAN	31 OCTOBER 2000	X				
I (we) hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below: (Application Number) (Filing Date) I (we) hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed							
L(wa) haraby claim the hanafit	under Title 35 United States Co	odo & 120 of any United States		lieted			
below and, insofar as the subje States application in the manne acknowledge the duty to disclose	ct matter of each of the claims of er provided by the first paragraph se information which is material the available between the filing di	ode, § 120 of any United States a of this application is not disclosed in of Title 35, United States Code to patentability as defined in Titl ate of the prior application and the	application(s) I d in the prior U e, § 112, I (we) e 37, Code of	Jnited) Federal			
below and, insofar as the subje States application in the manne acknowledge the duty to disclose Regulation, §1.56 which became	ct matter of each of the claims of er provided by the first paragraph se information which is material the available between the filing di	of this application is not disclosed in of Title 35, United States Code to patentability as defined in Titl	application(s) I d in the prior L e, § 112, I (we) e 37, Code of he national or I	Jnited) Federal PCT			

Docket No.: JG-SIK-5108 / 500676.20005 DECLARATION FOR PATENT APPLICATION

I (we) hereby appoint the Patent and T	int the followi rademark Of	ng attorney(s) and/or agent(s) to fice connected therewith and to a	prosecute this appart in accordance w	olication and to transact all business with the instructions from Siks & Co.		
Lloyd McAr Gerald H. k Stephen M Samir R. Pr Harry Ahn.	Kiel, 1. Chin, Patel,		Jules E. Goldberg Eugene LeDonne, Arthur Dresner, Daniel P. Lent;			
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Address all telephone calls to:		Jules E. Goldberg, Esq.	at Telephone No. (212) 521-5400			
Address all correspondence to: Customer No. 026418						
made on informatio knowledge that willf	on and belief a Iful false state tle 18 of the U	atements made herein of my (our) are believed to be true; and furthe ements and the like so made are published States Code and that such sued thereon.	er that these staten punishable by fine	nents were made with the		
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Residence:			Citizenship:			
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